

Amendments to the Specification:

Please add the following new paragraph immediately after the title on page 1:

--CROSS-REFERENCE TO RELATED APPLICATIONS

This application claims priority from U.S. Application Serial No. 09/931,554, filed on August 16, 2001, which is a continuation-in-part of U.S. Application Serial No. 09/537,829, filed on March 29, 2000.

Please replace the Abstract at page 85 with the following new Abstract:

-- Techniques for recycling waste particles may include solidifying particles, which were generated by machining a crystal ingot into a wafer or by machining a semiconductor wafer, into a cake, and melting the cake, for example, into an ingot.--

Attachment: Separate page with Abstract